

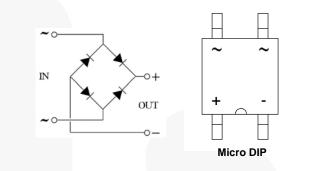
May 2013



MDB10SS 1 A, MicroDIP, Single-Phase Bridge Rectifiers

## Features

- Low Package Profile: 1.45 mm (max)
- Requires Only 35 mm<sup>2</sup> of Board Space
- High Surge Current Capability: 30 A (max)
- Glass Passivated Junction Rectifiers
- Smaller Plastic Body vs MDB10S
- Green Compound
- UL Certification: E352360



## **Absolute Maximum Ratings**

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only. Values are at  $T_A = 25^{\circ}C$  unless otherwise noted.

Symbol	Parameter	Value	Units
V <sub>RRM</sub>	Maximum Repetitive Peak Reverse Voltage	1000	V
V <sub>RMS</sub>	Maximum RMS Voltage	700	V
V <sub>DC</sub>	Maximum DC Blocking Voltage	1000	V
I <sub>F(AV)</sub>	Average Rectified Forward Current <sup>(1)</sup>	1.0	A
I <sub>FSM</sub>	Peak Forward Surge Current <sup>(2)</sup>	30	A
l <sup>2</sup> t	I <sup>2</sup> t Rating for fusing (t<8.3ms)	3.735	A <sup>2</sup> S
TJ	Operating Junction Temperature Range	-55 to +150	°C
T <sub>STG</sub>	Storage Temperature Range	-55 to +150	°C

Notes:

1. 60 Hz sine wave, R-load,  $T_A = 25^{\circ}C$  on FR-4 PCB.

2. 60 Hz sine wave, Non-repetitive 1 cycle peak value,  $T_J = 25^{\circ}C$ .

# Thermal Characteristics<sup>(3)</sup>

Symbol	Parameter		Тур.	Units
$R_{ extsf{ heta}JA}$	Thermal Resistance, Junction-Ambient	Measurement with Dual Dice	250	°C/W
		Measurement with Single Die	150	°C/W
$\psi_{JL}$	hermal ("haracterization" lunction to Lead	Measured at Anode pin	57	°C/W
		Measured at Cathode pin	15	°C/W

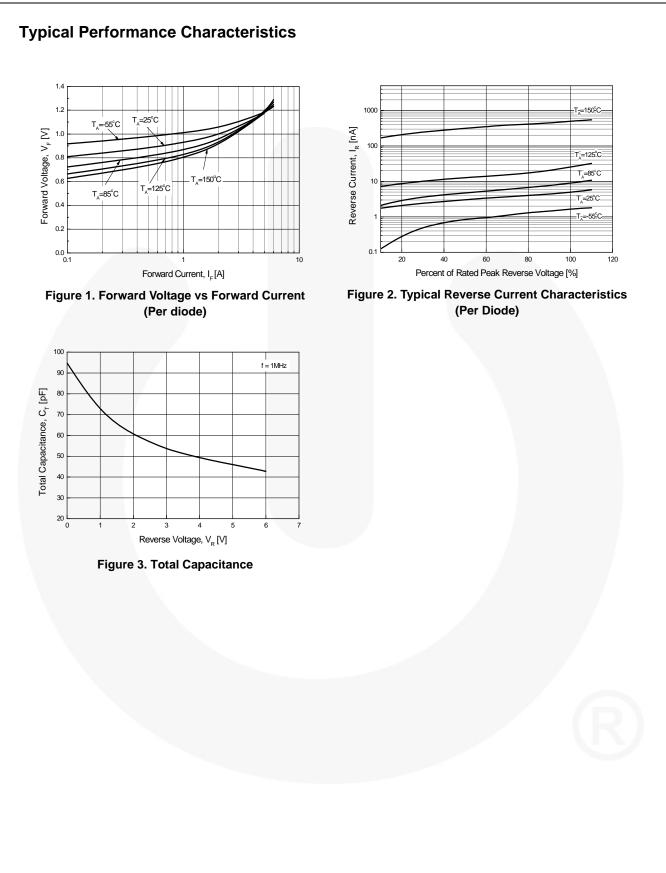
### Note:

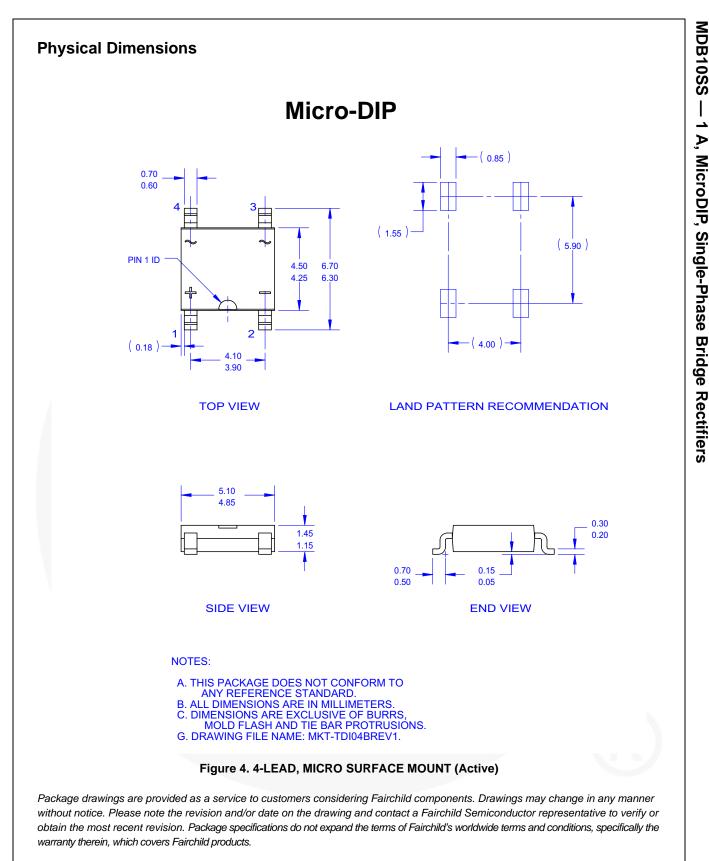
3. Device mounted on FR-4 PCB with board size = 76.2 mm x 114.3 mm (JESD51-3 standards)

# **Electrical Characteristics**

Values are at  $T_A = 25^{\circ}C$  unless otherwise specified.

Symbol	Parameter	Test condition	Value	Units
V <sub>F</sub>	Maximum Forward Voltage	I <sub>F</sub> = 1 A, Pulse measurement, Per diode	1.0	V
I <sub>R</sub>	Maximum Reverse Current	At V <sub>RRM</sub> , Pulse measurement, Per diode	10	μΑ
CJ	Typical Junction Capacitance	V <sub>R</sub> = 4 V, f = 1 MHz	10	pF





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